

Loctite® CHIPBONDER® 3621 Ultra High Speed, Syringe Dispense

Category : Polymer , Adhesive , Thermoset

Material Notes:

Surface Mount Adhesives Loctite® Chipbonder® Surface Mount Adhesives (SMAs) maintain component positioning during wave solder and solder reflow processes. Loctite offers a variety of application techniques including syringe dispense, stencil print and pin transfer. Loctite® syringe dispense products provide good performance for electronics assembly: High Speed Dispense Low Temperature Cure Products for difficult-to-bond substrates Loctite® 3621 CHIPBONDER® Ultra High Speed, Syringe Dispense Designed for high-speed syringe dispense. Excellent green strength. Improved humidity resistance. Jettable. Rounded dot profile. Process Method: Very high speed Syringe dispensing 47,000 DPH capable Jettable Storage (Protect from heat): 40°F (+/-5°F) or 5°C (+/-3°C)

Order this product through the following link:

http://www.lookpolymers.com/polymer_Loctite-CHIPBONDER-3621-Ultra-High-Speed-Syringe-Dispense.php

Processing Properties	Metric	English	Comments
Cure Time	1.50 min	0.0250 hour	
	@Temperature 150 °C	@Temperature 302 °F	
Shelf Life	6.00 Month	6.00 Month	From date of manufacture

Descriptive Properties	Value	Comments
Color	Red	

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